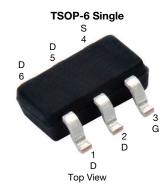
Si3440ADV

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Vishay Siliconix



N-Channel 150 V (D-S) MOSFET

FEATURES

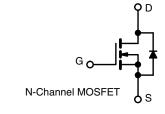
- ThunderFET[®] power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- DC/DC converters
- Boost converters
- LED backlighting
- PD switch
- Load switch



COMPLIANT HALOGEN



Marking code: BS

PRODUCT SUMMARY				
V _{DS} (V)	150			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.380			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.432			
Q _g typ. (nC)	1.65			
I _D (A) ^d	2.2			
Configuration	Single			

ORDERING INFORMATION

Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3440ADV-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	150	V	
Gate-source voltage		V _{GS}	V _{GS} ± 20		
	T _C = 25 °C		2.2		
Operation of the intervent (T 150 °C)	T _C = 70 °C	Τ.Γ	1.7		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C		1.6 ^{a, b}		
	T _A = 70 °C	1	1.3 ^{a, b}		
Pulsed drain current (t = 100 µs)		I _{DM}	4	— A	
Continuous source-drain diode current	T _C = 25 °C		3		
	T _A = 25 °C	I _S	1.7 ^{a, b}		
Single pulse avalanche current		I _{AS}	3		
Single pulse avalanche energy L = 0.1 mH		E _{AS}	0.45	mJ	
	T _C = 25 °C		3.6		
Maximum power dissipation	T _C = 70 °C	1 _ [2.3		
	T _A = 25 °C	P _D	2 ^{a, b}	W	
	T _A = 70 °C	1 F	1.3 ^{a, b}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 10 s	R _{thJA}	50	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	28	35	0/11	

Notes

a. Surface mounted on 1" x 1" FR4 board

- b. t = 10 s
- c. Maximum under steady state conditions is 110 $^{\circ}\text{C/W}$

d. $T_C = 25 \ ^{\circ}C$

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Document Number: 75594

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Si3440ADV

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•			•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	150	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$			135	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5.6	-	mv/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
		V _{DS} = 150 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V_{DS} = 150 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	4	-	-	Α
5	_	V _{GS} = 10 V, I _D = 1.5 A	-	0.316	0.380	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 1 A	-	0.345	0.432	
Forward transconductance ^a	g _{fs}	V _{DS} = 50 V, I _D = 1.5 A	-	2.4	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	80	-	
Output capacitance	C _{oss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz	-	26	-	pF
Reverse transfer capacitance	C _{rss}		-	3	-	
Total gate charge	Qg	V _{DS} = 75 V, V _{GS} = 10 V, I _D = 0.5 A	-	2	4	
			-	1.65	3	
Gate-source charge	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.5 \text{ A}$	-	0.5	-	– nC
Gate-drain charge	Q _{gd}		-	0.7	-	
Gate resistance	R _g	f = 1 MHz	0.7	3.5	7	Ω
Turn-on delay time	t _{d(on)}		-	8	16	
Rise time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_{\text{L}} = 57.7 \Omega, \text{ I}_{\text{D}} \cong 1.3 \text{ A},$	-	22	35	1
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	9	18	
Fall time	t _f		-	22	35	
Turn-on delay time	t _{d(on)}		-	10	20	ns
Rise time	t _r	V _{DD} = 75 V, R _I = 57.7 Ω, I _D ≅ 1.3 A,	-	25	40	1
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 7.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	10	20	1
Fall time	t _f	-	-	24	50	1
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	1.7	
Pulse diode forward current	I _{SM}		-	-	4	A
Body diode voltage	V _{SD}	I _S = 1.3 A, V _{GS} = 0 V	-	0.85	1.2	V
Body diode reverse recovery time	t _{rr}		-	44	66	ns
Body diode reverse recovery charge	Q _{rr}		-	53	80	nC
Reverse recovery fall time	ta	$I_F = 1.3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \ ^\circ\text{C}$	-	27	-	
Reverse recovery rise time	t _b		_	17	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

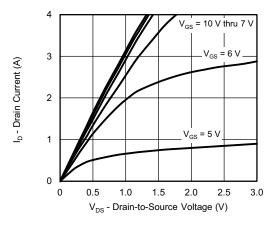
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

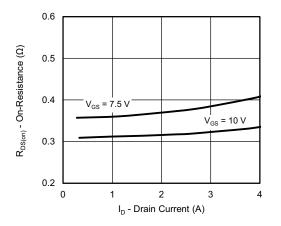
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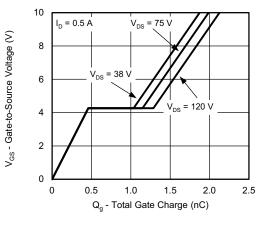
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



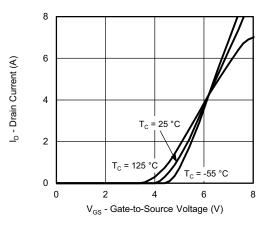
Output Characteristics



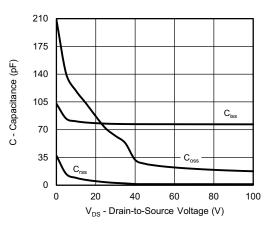
On-Resistance vs. Drain Current and Gate Voltage



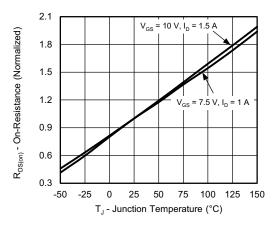
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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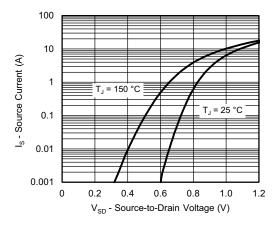
3

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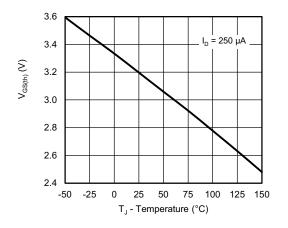
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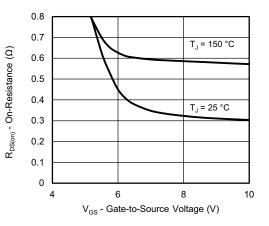
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



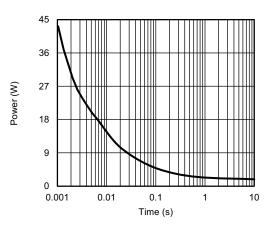
Source-Drain Diode Forward Voltage



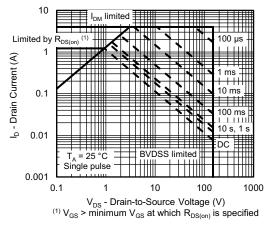
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

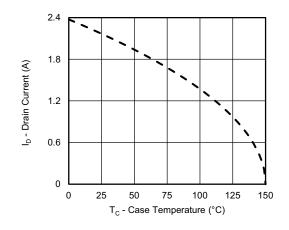
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4

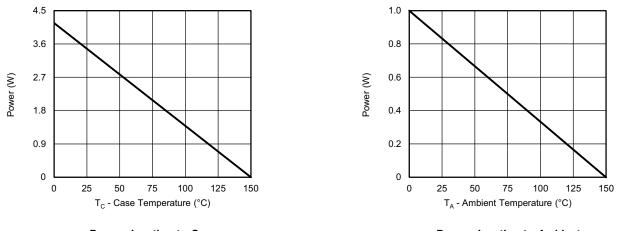
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

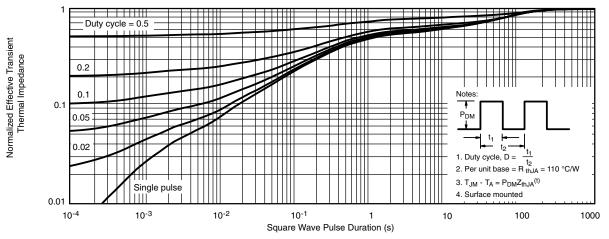
Power, Junction-to-Ambient

Note

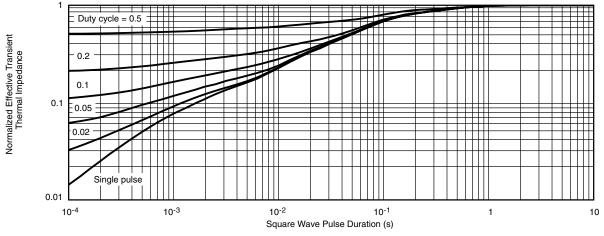
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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S17-0904-Rev. B, 12-Jun-17	6	Document Number: 75594
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Package Information

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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



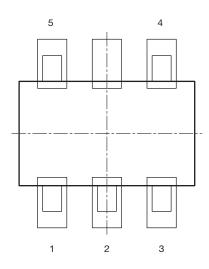
	MILLIMETERS			INCHES					
Dim	Min	Nom	Max	Min	Nom	Max			
Α	0.91	-	1.10	0.036	-	0.043			
A ₁	0.01	-	0.10	0.0004	-	0.004			
A ₂	0.90	-	1.00	0.035	0.038	0.039			
b	0.30	0.32	0.45	0.012	0.013	0.018			
С	0.10	0.15	0.20	0.004	0.006	0.008			
D	2.95	3.05	3.10	0.116	0.120	0.122			
Е	2.70	2.85	2.98	0.106	0.112	0.117			
E ₁	1.55	1.65	1.70	0.061	0.065	0.067			
е	0.95 BSC			0.0374 BSC					
e ₁	1.80	1.90	2.00	0.071	0.075	0.079			
L	0.32	-	0.50	0.012	-	0.020			
L ₁		0.60 Ref			0.024 Ref				
L ₂	0.25 BSC				0.010 BSC				
R	0.10	-	-	0.004	-	-			
θ	0°	4°	8°	0°	4°	8°			
θ_1	7° Nom				7° Nom				
		ev. I, 18-Dec	c-06			ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540			

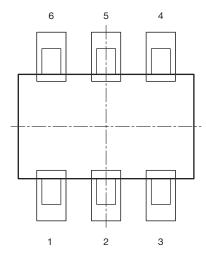
PAD Pattern



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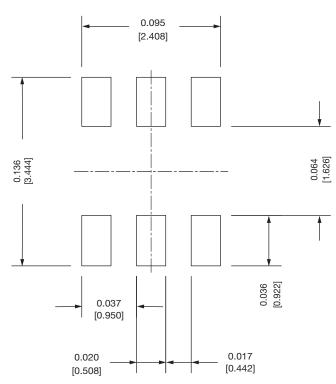
Recommended Land Pattern For TSOP-5L / TSOP-6L





TSOP 5L





Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022	
DWG: 3010	

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Revision: 01-Jan-2025

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